NP0G3D3

Silicon PNP epitaxial planar type (Tr1) Silicon NPN epitaxial planar type (Tr2)

For digital circuits

Features

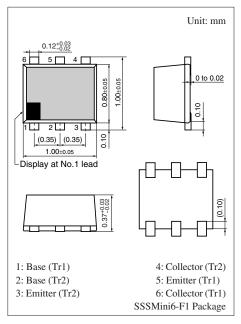
- Two elements incorporated into one package
- Suitable for high-density mounting and downsizing of the equipment
- Automatic insertion with the taping is possible

Basic Part Number

• UNR31A3 + UNR32AT

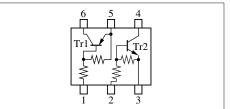
Absolute Maximum Ratings $T_a = 25^{\circ}C$							
Parameter		Symbol	Rating	Unit			
Tr1	Collector-base voltage (Emitter open)	V _{CBO}	-50	V			
	Collector-emitter voltage (Base open)	V _{CEO}	-50	V			
	Collector current	I _C	-80	mA			
Tr2	Collector-base voltage (Emitter open)	V _{CBO}	50	V			
	Collector-emitter voltage (Base open)	V _{CEO}	50	V			
	Collector current	I _C	80	mA			
Overall	Total power dissipation *	P _T	125	mW			
	Junction temperature	Tj	125	°C			
	Storage temperature	T _{stg}	-55 to +125	°C			

Note) *: Measuring on substrate at 17 mm \times 10 mm \times 1 mm



Marking Symbol: 3H

Internal Connection



Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

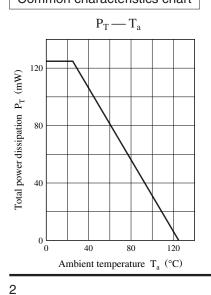
• Tr1

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = -10 \ \mu A, \ I_{\rm E} = 0$	-50			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$	-50			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = -50 \text{ V}, I_E = 0$			- 0.1	μΑ
Collector-emitter cutoff current (Base open)	I _{CEO}	$V_{CE} = -50 \text{ V}, I_B = 0$			- 0.5	μΑ
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = -6 V, I_C = 0$			- 0.1	mA
Forward current transfer ratio	h _{FE}	$V_{CE} = -10 \text{ V}, I_C = -5 \text{ mA}$	80			
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = -10$ mA, $I_{\rm B} = -0.3$ mA			- 0.25	V
Output voltage high-level	V _{OH}	$V_{CC} = -5 \text{ V}, V_B = -0.5 \text{ V}, R_L = 1 \text{ k}\Omega$	-4.9			V
Output voltage low-level	V _{OL}	$V_{CC} = -5 \text{ V}, V_B = -3.5 \text{ V}, R_L = 1 \text{ k}\Omega$			- 0.2	V
Input resistance	R ₁		-30%	47	+30%	kΩ
Resistance ratio	R ₁ / R ₂		0.8	1.0	1.2	
Transition frequency	f _T	$V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$		80		MHz

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. • Tr2

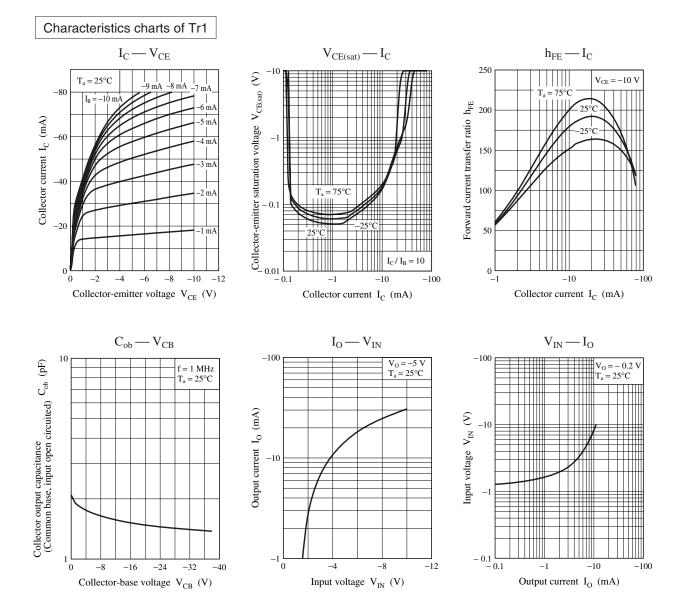
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 10 \ \mu A, \ I_{\rm E} = 0$	50			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 2 \text{ mA}, I_{\rm B} = 0$	50			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 50 V, I_E = 0$			0.1	μΑ
Collector-emitter cutoff current (Base open)	I _{CEO}	$V_{CE} = 50 \text{ V}, I_B = 0$			0.5	μΑ
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = 6 V, I_C = 0$			0.2	mA
Forward current transfer ratio	h _{FE}	$V_{CE} = 10 \text{ V}, I_C = 5 \text{ mA}$	80		400	—
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 0.3 \text{ mA}$			0.25	V
Output voltage high-level	V _{OH}	$V_{CC} = 5 \text{ V}, V_{B} = 0.5 \text{V}, \text{R}_{L} = 1 \text{k}\Omega$	4.9			V
Output voltage low-level	V _{OL}	$V_{CC} = 5 \text{ V}, V_{B} = 2.5 \text{ V}, R_{L} = 1 k\Omega$			0.2	V
Input resistance	R ₁		-30%	22	+30%	kΩ
Resistance ratio	R ₁ / R ₂			0.47		
Transition frequency	f _T	$V_{CB} = 10 \text{ V}, I_E = -2 \text{ mA}, f = 200 \text{ MHz}$		150		MHz

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.



SJJ00275AED

Panasonic



Panasonic

NP0G3D3

80

60

40

20

0

10

1 ∟ 0

10

20

Collector-base voltage V_{CB} (V)

30

40

Collector output capacitance (Common base, input open circuited) C_{ob} (pF)

0

Collector current I_C (mA)

Characteristics charts of Tr2 $V_{CE(sat)}$ — I_C $I_C - V_{CE}$ $h_{FE}\!-\!\!-I_C$ 10 400 $I_B = 1.0 \text{ mA} 0.9 \text{ mA} 0.8 \text{ mA} 0.7 \text{ mA} 0.6 \text{ mA} 0.5 \text{ mA}$ Collector-emitter saturation voltage $V_{CE(sat)}$ (V) $V_{CE} = 10 V$ 0.3 mÅ Forward current transfer ratio h_{FE} 259 $T_a = 75^{\circ}C$ 0.2 mA 300 0.4 mA 200 $T_a = 75^{\circ}C$ 0.1 mA -----0.1 100 -25°C $T_a = 25^{\circ}C$ I_C / I_B 10 0.01 0 2 4 6 10 12 10 100 8 1 10 100 1 Collector-emitter voltage V_{CE} (V) Collector current I_C (mA) Collector current I_C (mA) $I_0 - V_{IN}$ $C_{ob} - V_{CB}$ V_{IN} — I_O 100 10 $V_{O} = 5 V$ $T_{a} = 25^{\circ}C$ f = 1 MHz $T_a = 25^{\circ}C$ $V_{O} = 0.2 V$ $T_{a} = 25^{\circ}C$ Output current I₀ (mA) Input voltage V_{IN} (V) 10

0.1

10

1

Output current I_0 (mA)

100

0.1 L

1

Input voltage V_{IN} (V)

2

4

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